NB6L239

2.5V / 3.3V Any Differential Clock IN to Differential LVPECL OUT ÷1/2/4/8, ÷2/4/8/16 Clock Divider

Description

The NB6L239 is a high−speed, low skew clock divider with two divider circuits, each having selectable clock divide ratios; ÷1/2/4/8 and ÷2/4/8/16. Both divider circuits drive a pair of differential LVPECL outputs. (More device information on page 7). The NB6L239 is a member of the ECLinPS MAX™ Family of the high performance clock products.
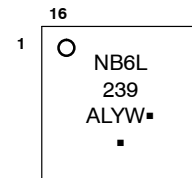
Features

- Maximum Clock Input Frequency, 3.0 GHz
- CLOCK Inputs Compatible with LVDS/LVPECL/CML/HSTL/HCSL
- $\overline{EN}$, $\overline{MR}$, and SEL Inputs Compatible with LVTTL/LVCMOS
- Rise/Fall Time 65 ps Typical
- < 10 ps Typical Output−to−Output Skew
- Example: 622.08 MHz Input Generates 38.88 MHz to 622.08 MHz Outputs
- Internal 50 Ω Termination Provided
- Random Clock Jitter < 1 ps RMS
- QA ÷ 1 Edge Aligned to QB ÷ n Edge
- Operating Range: V_{CC} = 2.375 V to 3.465 V with V_{EE} = 0 V
- Master Reset for Synchronization of Multiple Chips
- V_{BBAC} Reference Output
- Synchronous Output Enable/Disable
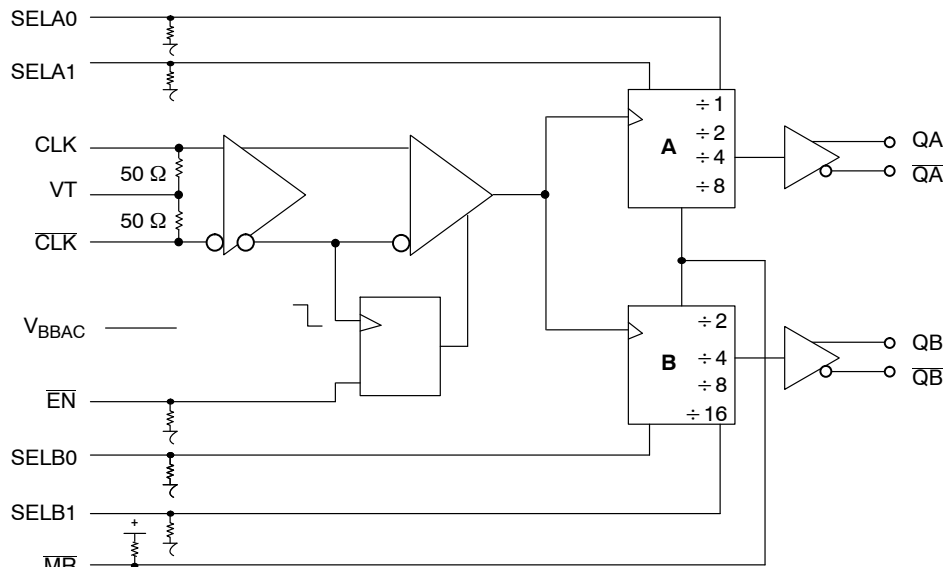- These Devices are Pb−Free and are RoHS Compliant

Figure 1. Simplified Logic Diagram

NB6L239
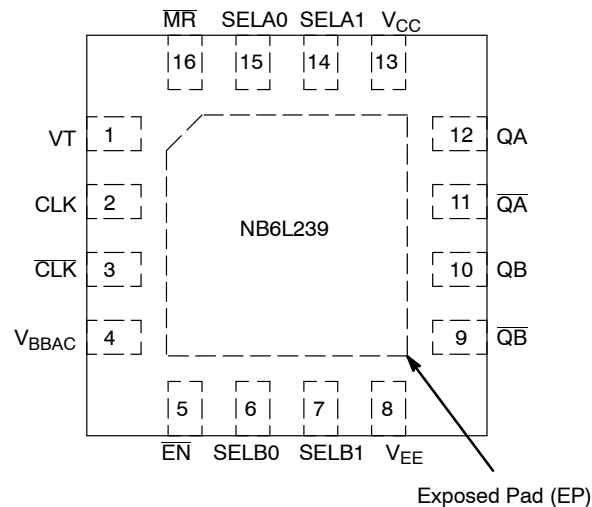
Figure 2. Pinout: QFN−16 (Top View)

Table 1. PIN DESCRIPTION

Pin	Name	I/O	Description
1	VT		Internal 100 Ω Center−Tapped Termination Pin for CLK and $\overline{CLK}$.
2	CLK	LVPECL, CML, LVDS, HCSL, HSTL Input	Noninverted Differential CLOCK Input.
3	$\overline{CLK}$	LVPECL, CML, LVDS, HCSL, HSTL Input	Inverted Differential CLOCK Input.
4	V_{BBAC}		Output Voltage Reference for Capacitor Coupled Inputs, Only.
5	$\overline{EN}$*	LVCMOS/LVTTL Input	Synchronous Output Enable
6	SELB0*	LVCMOS/LVTTL Input	Clock Divide Select Pin
7	SELB1*	LVCMOS/LVTTL Input	Clock Divide Select Pin
8	V_{EE}	Power Supply	Negative Supply Voltage
9	$\overline{QB}$	LVPECL Output	Inverted Differential Output. Typically terminated with 50 Ω resistor to V_{CC} − 2.0 V.
10	QB	LVPECL Output	Noninverted Differential Output. Typically terminated with 50 Ω resistor to V_{CC} − 2.0 V.
11	$\overline{QA}$	LVPECL Output	Inverted Differential Output. Typically terminated with 50 Ω resistor to V_{CC} − 2.0 V.
12	QA	LVPECL Output	Noninverted Differential Output. Typically terminated with 50 Ω resistor to V_{CC} − 2.0 V.
13	V_{CC}	Power Supply	Positive Supply Voltage.
14	SELA1*	LVCMOS/LVTTL Input	Clock Divide Select Pin
15	SELA0*	LVCMOS/LVTTL Input	Clock Divide Select Pin
16	$\overline{MR}$**	LVCMOS/LVTTL Input	Master Reset Asynchronous, Default Open High, Asserted LOW
	EP	Power Supply (OPT)	The Exposed Pad on the QFN−16 package bottom is thermally connected to the die for improved heat transfer out of package. The pad is electrically connected to the die, and is recommended to be electrically and thermally connected to V_{EE} on the PC board.

*Pins will default LOW when left OPEN.
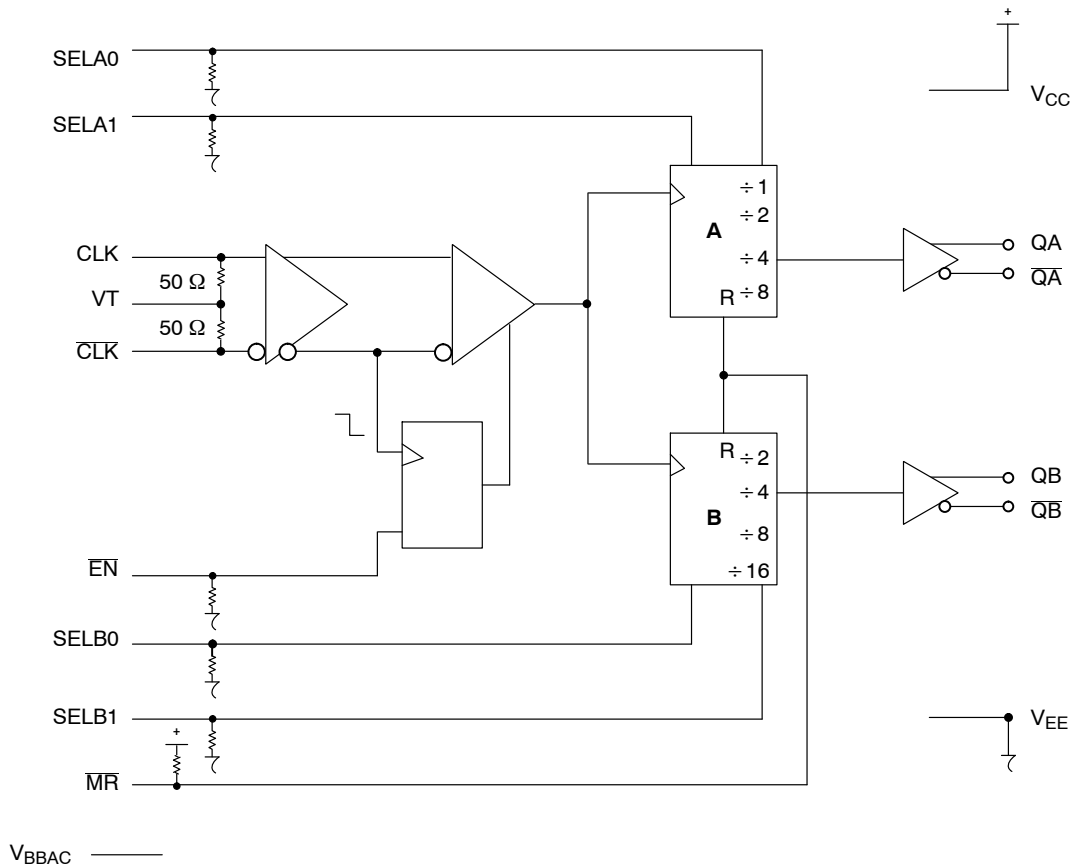**Pins will default HIGH when left OPEN.

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Figure 3. Logic Diagram

Table 2. FUNCTION TABLE

CLK	EN̄*	MR̄**	FUNCTION
⌐	L	H	Divide
⌐_	H	H	Hold Q
X	X	L	Reset Q

Table 3. CLOCK DIVIDE SELECT, QA OUTPUTS

SELA1*	SELA0*		QA Outputs
L	L		Divide by 1
L	H		Divide by 2
H	L		Divide by 4
H	H		Divide by 8

Table 4. CLOCK DIVIDE SELECT, QB OUTPUTS

SELB1*	SELB0*		QB Outputs
L	L		Divide by 2
L	H		Divide by 4
H	L		Divide by 8
H	H		Divide by 16

⌐ = Low−to−High Transition
⌐_ = High−to−Low Transition
 X = Don't Care
 *Pins will default LOW when left OPEN.
 **Pins will default HIGH when left OPEN.

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Table 5. ATTRIBUTES

Characteristics		Value
Internal Input Pulldown Resistor		75 kΩ
Internal Input Pullup Resistor		75 kΩ
ESD Protection	Human Body Model	> 1500 V
	Machine Model	> 150 V
	Charged Device Model	> 1000 V
Moisture Sensitivity, Indefinite Time Out of Drypack (Note 1)		Pb−Free Pkg
	QFN−16	Level 1
Flammability Rating	Oxygen Index: 28 to 34	UL 94 V−0 @ 0.125 in
Transistor Count		367
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test		

1. For additional Moisture Sensitivity information, refer to Application Note AND8003/D.

MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V_{CC}	Positive Mode Power Supply	$V_{EE} = 0$ V		3.6	V
V_I	Input Voltage	$V_{EE} = 0$ V	$V_{EE} \leq V_I \leq V_{CC}$	3.6	V
I_{out}	Output Current	Continuous		50	mA
		Surge		100	mA
I_{BB}	V_{BBAC} Sink/Source Current			± 0.5	mA
T_A	Operating Temperature Range			−40 to +85	°C
T_{stg}	Storage Temperature Range			−65 to +150	°C
θ_{JA}	Thermal Resistance (Junction−to−Ambient)	0 lfpm		41.6	°C/W
		500 lfpm		35.2	°C/W
θ_{JC}	Thermal Resistance (Junction−to−Case)	Standard Board		4.0	°C/W
T_{sol}	Wave Solder Pb−Free			265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 6. DC CHARACTERISTICS, CLOCK INPUTS, LVPECL OUTPUTS

(V_{CC} = 2.375 V to 3.465 V, V_{EE} = 0 V)

Symbol	Characteristic	−40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I_{EE}	Power Supply Current	30	40	50	30	40	50	30	40	50	mA
V_{OH}	Output HIGH Voltage (Notes 2, 3)	V_{CC}−1150	V_{CC}−1060	V_{CC}−950	V_{CC}−1100	V_{CC}−1015	V_{CC} − 900	V_{CC}−1050	V_{CC} −980	V_{CC} − 850	mV
	V_{CC} = 3.3 V	2150	2240	2350	2200	2285	2400	2250	2320	2450	
	V_{CC} = 2.5 V	1350	1440	1550	1400	1485	1600	1450	1520	1650	
V_{OL}	Output LOW Voltage (Notes 2, 3)	V_{CC}−1935	V_{CC}−1775	V_{CC}−1630	V_{CC}−1875	V_{CC}−1735	V_{CC}−1580	V_{CC}−1810	V_{CC}−1675	V_{CC}−1530	mV
	V_{CC} = 3.3 V	1365	1525	1670	1430	1565	1720	1490	1625	1770	
	V_{CC} = 2.5 V	565	725	870	630	765	920	690	825	970	

DIFFERENTIAL INPUT DRIVEN SINGLE−ENDED (Figures 7, 10)

Symbol	Characteristic	−40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
V_{th}	Input Threshold Reference Voltage (Note 4)	100		V_{CC} − 100	100		V_{CC} − 100	100		V_{CC} − 100	mV
V_{IH}	Single−ended Input HIGH Voltage	V_{th} + 100		V_{CC}	V_{th} + 100		V_{CC}	V_{th} + 100		V_{CC}	mV
V_{IL}	Single−ended Input LOW Voltage	V_{EE}		V_{th} − 100	V_{EE}		V_{th} − 100	V_{EE}		V_{th} − 100	mV
V_{BBAC}	Output Voltage Reference @ 100 µA (Note 7)	V_{CC}−1460	V_{CC}−1330	V_{CC}−1200	V_{CC}−1460	V_{CC}−1340	V_{CC}−1200	V_{CC}−1460	V_{CC}−1350	V_{CC}−1200	mV
	V_{CC} = 3.3 V	1840	1970	2100	1840	1960	2100	1840	1950	2100	
	V_{CC} = 2.5 V	1040	1170	1300	1040	1160	1300	1040	1150	1300	

DIFFERENTIAL INPUT DRIVEN DIFFERENTIALLY (Figures 8, 9, 11) (Note 6)

Symbol	Characteristic	−40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
V_{IHD}	Differential Input HIGH Voltage	100		V_{CC}	100		V_{CC}	100		V_{CC}	mV
V_{ILD}	Differential Input LOW Voltage	V_{EE}		V_{CC} − 100	V_{EE}		V_{CC} − 100	V_{EE}		V_{CC} − 100	mV
V_{CMR}	Input Common Mode Range (Differential Cross−point Voltage) (Note 5)	50		V_{CC} − 50	50		V_{CC} − 50	50		V_{CC} − 50	mV
V_{ID}	Differential Input Voltage ($V_{IHD(CLK)}$ − $V_{ILD(CLK)}$) and ($\overline{V_{IHD(CLK)}}$−$\overline{V_{ILD(CLK)}}$)	100		V_{CC} − V_{EE}	100		V_{CC} − V_{EE}	100		V_{CC} − V_{EE}	mV
R_{TIN}	Internal Input Termination Resistor	45	50	55	45	50	55	45	50	55	Ω

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

2. Input and output parameters vary 1:1 with V_{CC}.
3. Outputs loaded with 50 Ω to V_{CC} − 2.0 V for proper operation.
4. V_{th} is applied to the complementary input when operating in single−ended mode.
5. VCMR$_{MIN}$ varies 1:1 with V_{EE}, VCMR$_{MAX}$ varies 1:1 with V_{CC}.
6. Input and output voltage swing is a single−ended measurement operating in differential mode.
7. V_{BBAC} used to rebias capacitor−coupled inputs only (see Figures 16 and 17).

Table 7. DC CHARACTERISTICS, LVTTL/LVCMOS INPUTS (V_{CC} = 2.375 V to 3.465 V, V_{EE} = 0 V, T_A = −40°C to +85°C)

Symbol	Characteristic	Min	Typ	Max	Unit
V_{IH}	Input HIGH Voltage (LVCMOS/LVTTL)	2.0		V_{CC}	V
V_{IL}	Input LOW Voltage (LVCMOS/LVTTL)	V_{EE}		0.8	V
I_{IH}	Input HIGH Current	−150		150	μA
I_{IL}	Input LOW Current	−150		150	μA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

Table 8. AC CHARACTERISTICS V_{CC} = 2.375 V to 3.465 V; V_{EE} = 0 V (Note 8)

Symbol	Characteristic	−40°C Min	−40°C Typ	−40°C Max	25°C Min	25°C Typ	25°C Max	85°C Min	85°C Typ	85°C Max	Unit
f_{inMAX}	Maximum Input CLOCK Frequency	3.0			3.0			3.0			GHz
V_{OUTPP}	Output Voltage Amplitude (Notes 10, 11) QA(÷ 2, 4, 8), QB(÷ n) $f_{in} \leq$ 3.0 GHz QA(÷ 1), QB(÷ n) $f_{in} \leq$ 2.5 GHz QA(÷ 1), QB(÷ n) 2.5 GHz < $f_{in} \leq$ 3.0 GHz	450 450 300	650 650 650		450 450 250	650 630 650		450 450 200	650 610 650		mV
t_{PLH}, t_{PHL}	Propagation Delay to CLK, Qn Output Differential @ 50 MHz $\overline{MR}$, Qn	370 330	470 370	570 430	370 330	470 380	570 430	400 330	500 400	600 480	ps
t_{RR}	Reset Recovery	0	−90		0	−90		0	−90		ps
t_s	Setup Time @ 50 MHz $\overline{EN}$, CLK SELA/B, CLK	0 0	−60 −300		0 0	−60 −300		0 0	−60 −300		ps
t_h	Hold Time @ 50 MHz CLK, $\overline{EN}$ CLK, SELA/B	150 700	65 200		150 700	65 200		150 700	65 200		ps
t_{skew}	Within−Device Skew @ 50 MHz (Note 9) Device−to−Device Skew (Note 9) Duty Cycle Skew (Note 9)		5 25 25	30 80 40		5 30 30	30 90 45		6 30 30	35 90 45	ps
t_{PW}	Minimum Pulse Width $\overline{MR}$	550			550			550			ps
t_{JITTER}	RMS Random Clock Jitter (See Figure 20. F_{max}/JITTER)			< 1			< 1			< 1	ps
V_{INPP}	Input Voltage Swing (Differential Configuration) (Note 10)	100		V_{CC} $-V_{EE}$	100		V_{CC} $-V_{EE}$	100		V_{CC} $-V_{EE}$	mV
t_r t_f	Output Rise/Fall Times @ 50 MHz Qn, $\overline{Qn}$ (20% − 80%)	30	60	120	30	65	120	30	70	120	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

8. Measured using a 750 mV, 50% duty cycle clock source. All loading with 50 Ω to V_{CC} − 2.0 V.
9. Skew is measured between outputs under identical transitions and conditions. Duty cycle skew is defined only for differential operation when the delays are measured from the cross point of the inputs to the cross point of the outputs.
10. Input and output voltage swing is a single−ended measurement operating in differential mode.
11. Output Voltage Amplitude (V_{OHCLK} − V_{OLCLK}) at input CLOCK frequency, f_{in}. The output frequency, f_{out}, is the input CLOCK frequency divided by n, $f_{out} = f_{in} \div$ n. Input CLOCK frequency is $\leq$3.0 GHz.

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Application Information

The NB6L239 is a high−speed, low skew clock divider with two divider circuits, each having selectable clock divide ratios; ÷1/2/4/8 and ÷2/4/8/16. Both divider circuits drive a pair of differential LVPECL outputs. The internal dividers are synchronous to each other. Therefore, the common output edges are precisely aligned.

The NB6L239 clock inputs can be driven by a variety of differential signal level technologies including LVDS, LVPECL, HCSL, HSTL, or CML. The differential clock input buffer employs a pair of internal 50 Ω termination resistors in a 100 Ω center−tapped configuration and accessible via the VT pin. This feature provides transmission line termination on−chip, at the receiver end, eliminating external components. The V_{BBAC} reference output can be used to rebias capacitor−coupled

differential or single−ended input CLOCK signals. For the capacitor−coupled CLK and/or $\overline{CLK}$ inputs, V_{BBAC} should be connected to the V_T pin and bypassed to ground with a 0.01 μF capacitor. Inputs CLK and $\overline{CLK}$ must be signal driven or auto oscillation may result.

The common enable ($\overline{EN}$) is synchronous so that the internal divider flip−flops will only be enabled/disabled when the internal clock is in the LOW state. This avoids any chance of generating a runt pulse on the internal clock when the device is enabled/disabled, as can happen with an asynchronous control. The internal enable flip−flop is clocked on the falling edge of the input clock. Therefore, all associated specification limits are referenced to the negative edge of the clock input.
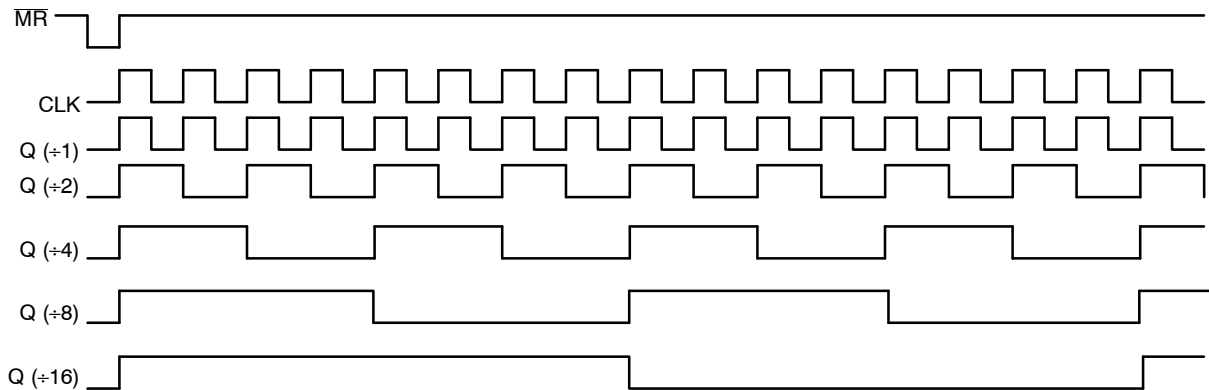
Figure 4. Timing Diagram
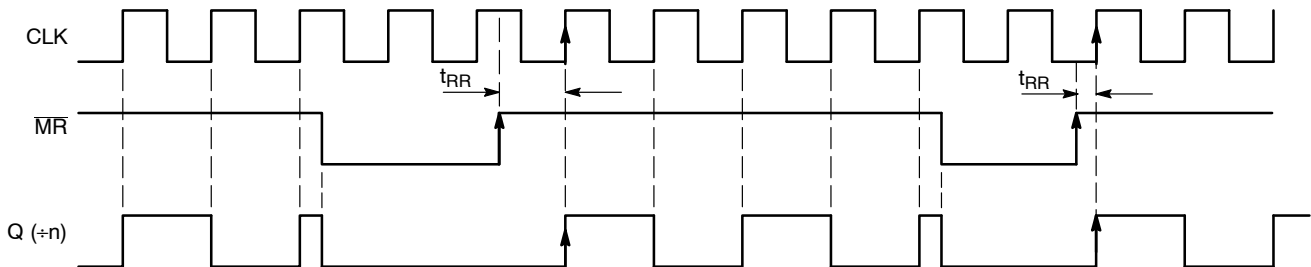
Figure 5. Master Reset Timing Diagram

NOTE: On the rising edge of $\overline{MR}$, Q goes HIGH after the first rising edge of CLK.
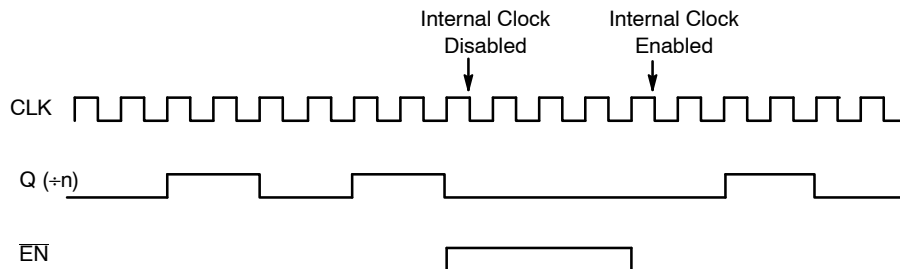
Figure 6. Output Enable Timing Diagrams

The $\overline{EN}$ signal will "freeze" the internal divider flip−flops on the first falling edge of CLK after its assertion. The internal divider flip−flops will maintain their state during the freeze. When $\overline{EN}$ is deasserted (LOW), and after the next falling edge of CLK, then the internal divider flip−flops will "unfreeze" and continue to their next state count with proper phase relationships.
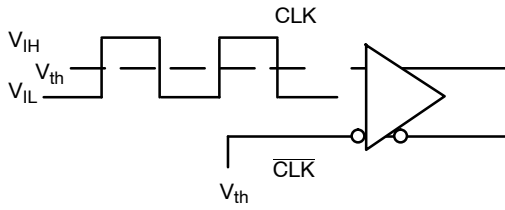
Figure 7. Differential Input Driven Single−Ended
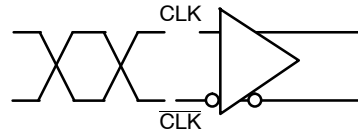
Figure 8. Differential Inputs Driven Differentially
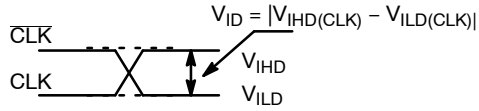
Figure 9. Differential Inputs Driven Differentially
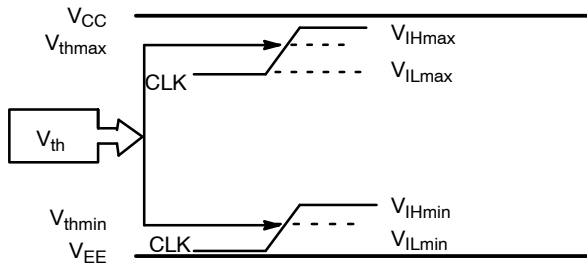
Figure 10. V_{th} Diagram

Figure 11. V_{CMR} Diagram

NB6L239
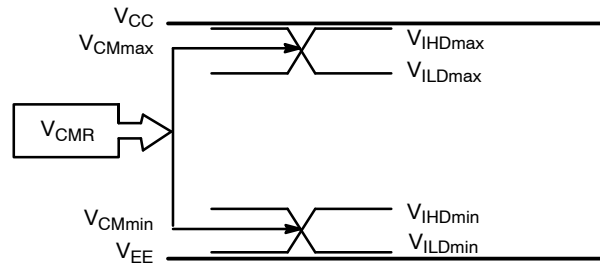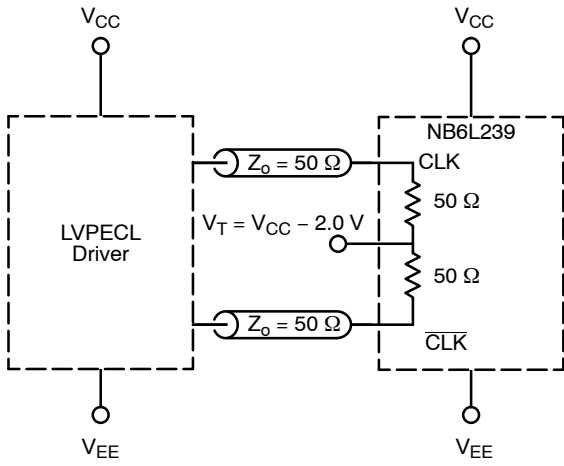
Figure 12. LVPECL Interface

Components: LVPECL Driver, $Z_o = 50\ \Omega$, $V_T = V_{CC} - 2.0\ V$, NB6L239 with CLK, 50 Ω, 50 Ω, $\overline{CLK}$
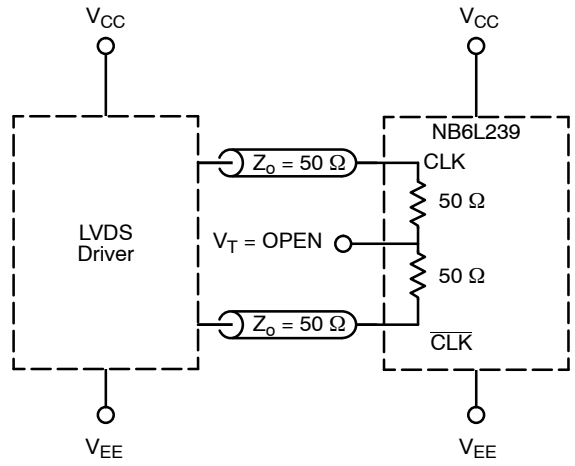
Figure 13. LVDS Interface

Components: LVDS Driver, $Z_o = 50\ \Omega$, $V_T = OPEN$, NB6L239 with CLK, 50 Ω, 50 Ω, $\overline{CLK}$

Figure 14. Standard 50 Ω Load CML Interface

Components: CML Driver, $Z_o = 50\ \Omega$, $V_T = V_{CC}$, NB6L239 with CLK, 50 Ω, 50 Ω, $\overline{CLK}$
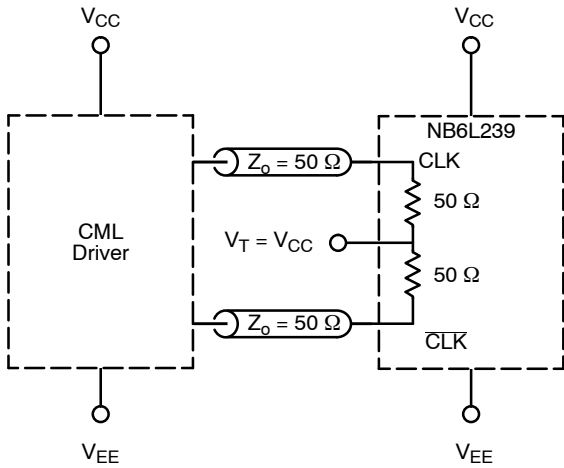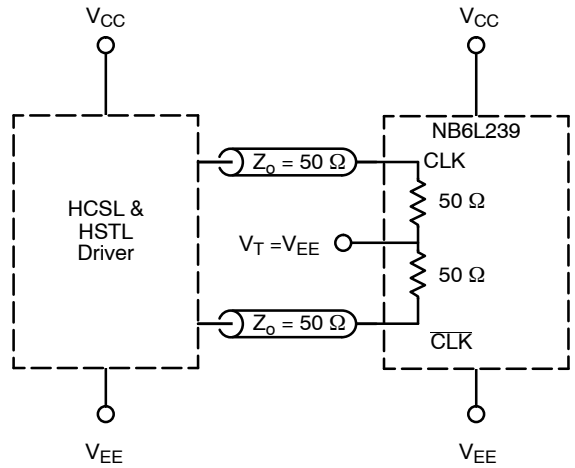
Figure 15. Standard 50 Ω Load HCSL & HSTL Interface

Components: HCSL & HSTL Driver, $Z_o = 50\ \Omega$, $V_T = V_{EE}$, NB6L239 with CLK, 50 Ω, 50 Ω, $\overline{CLK}$
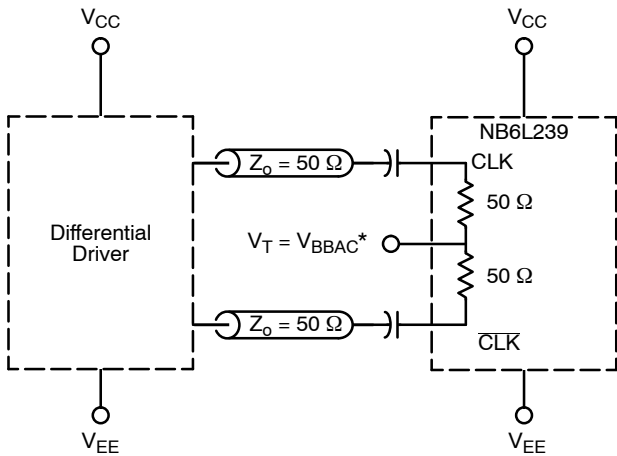
Figure 16. Capacitor−Coupled Differential Interface (V_T Connected to V_{BBAC})

Components: Differential Driver, $Z_o = 50\ \Omega$, $V_T = V_{BBAC}*$, NB6L239 with CLK, 50 Ω, 50 Ω, $\overline{CLK}$
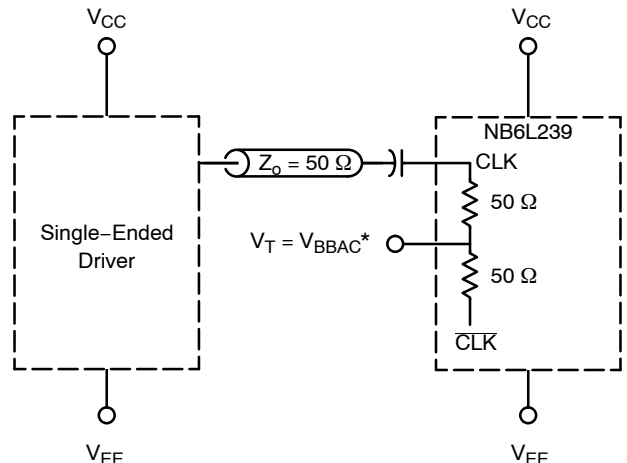
Figure 17. Capacitor−Coupled Single−Ended Interface (V_T Connected to V_{BBAC})

Components: Single−Ended Driver, $Z_o = 50\ \Omega$, $V_T = V_{BBAC}*$, NB6L239 with CLK, 50 Ω, 50 Ω, $\overline{CLK}$

*V_{BBAC} bypassed to ground with a 0.01 μF capacitor.
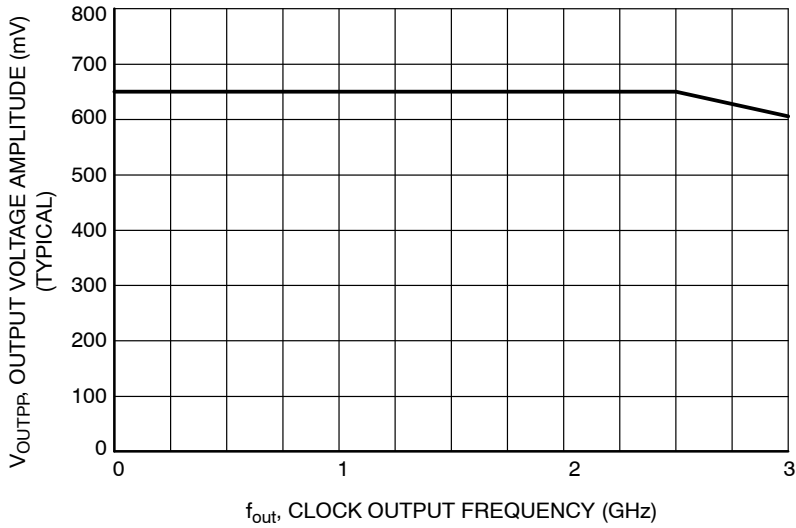
**Figure 18. Output Voltage Amplitude (V_{OUTPP}) versus
Clock Output Frequency at Ambient Temperature (Typical) (f_{out} QA/QB) = f_{in} ÷ n; f_{in} ≤ 3.0 GHz).**

$V_{INPP} = V_{IH}(CLK) - V_{IL}(CLK)$

$V_{OUTPP} = V_{OH}(Q) - V_{OL}(Q)$
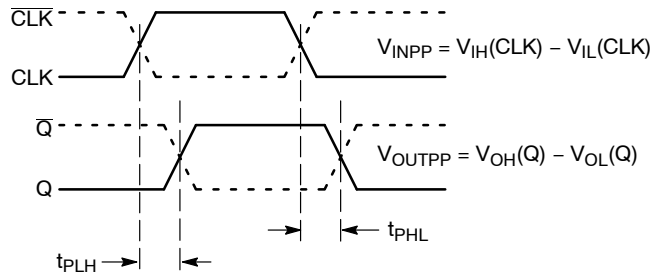
Figure 19. AC Reference Measurement
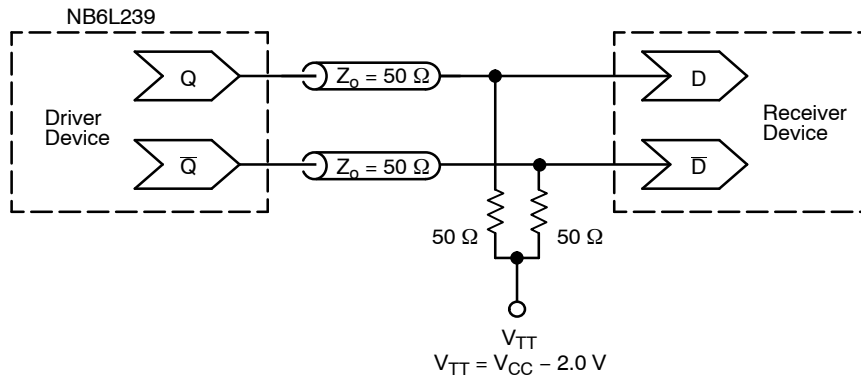
**Figure 20. Typical Termination for Output Driver and Device Evaluation
(See Application Note AND8020/D – Termination of ECL Logic Devices.)**

ORDERING INFORMATION

Device	Package	Shipping†
NB6L239MNG	QFN−16, 3 x 3 mm (Pb−Free)	123 Units / Rail
NB6L239MNR2G	QFN−16, 3 x 3 mm (Pb−Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Resource Reference of Application Notes

AN1405/D – ECL Clock Distribution Techniques

AN1406/D – Designing with PECL (ECL at +5.0 V)

AN1503/D – ECLinPS I/O SPiCE Modeling Kit

AN1504/D – Metastability and the ECLinPS Family

AN1568/D – Interfacing Between LVDS and ECL

AN1672/D – The ECL Translator Guide

AND8001/D – Odd Number Counters Design

AND8002/D – Marking and Date Codes

AND8020/D – Termination of ECL Logic Devices

AND8066/D – Interfacing with ECLinPS

AND8090/D – AC Characteristics of ECL Devices

PACKAGE DIMENSIONS

QFN16 3x3, 0.5P
CASE 485G
ISSUE F
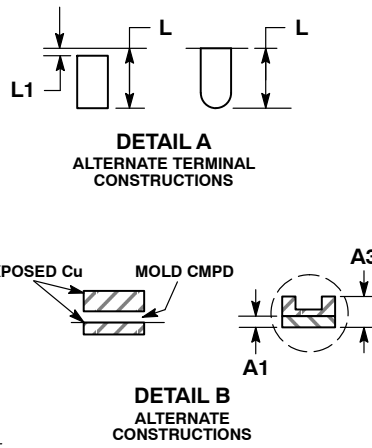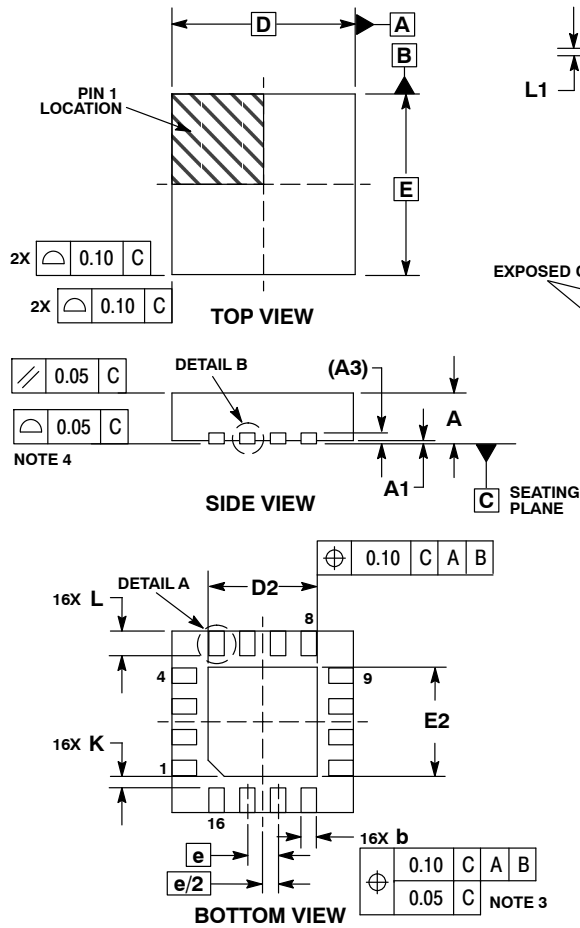
NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

DETAIL A
ALTERNATE TERMINAL CONSTRUCTIONS

DETAIL B
ALTERNATE CONSTRUCTIONS

EXPOSED Cu   MOLD CMPD

TOP VIEW

PIN 1 LOCATION

2X ⌀ 0.10 C
2X ⌀ 0.10 C

SIDE VIEW

⫽ 0.05 C
⌀ 0.05 C
NOTE 4

DETAIL B

SEATING PLANE

DIM	MILLIMETERS		
	MIN	NOM	MAX
A	0.80	0.90	1.00
A1	0.00	0.03	0.05
A3	0.20 REF		
b	0.18	0.24	0.30
D	3.00 BSC		
D2	1.65	1.75	1.85
E	3.00 BSC		
E2	1.65	1.75	1.85
e	0.50 BSC		
K	0.18 TYP		
L	0.30	0.40	0.50
L1	0.00	0.08	0.15

BOTTOM VIEW

⊕ 0.10 C A B

DETAIL A
16X L
16X K
16X b

⊕ 0.10 C A B
0.05 C   NOTE 3

RECOMMENDED SOLDERING FOOTPRINT*

PACKAGE OUTLINE

16X 0.58
2X 1.84
2X 3.30
16X 0.30
0.50 PITCH
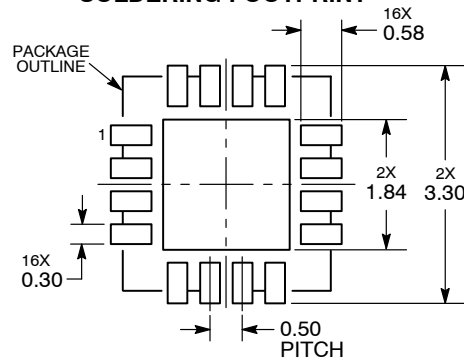
DIMENSIONS: MILLIMETERS

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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